



JAE Electronics, Inc.  
October 28<sup>th</sup>, 2016

## PCN (Process Change Notice) MX19004S51 & MX19004S52 Additional Mold Die & Additional Production Site To Keep Production Capacity

Part Number	Existing Mold Die with 2 Cavities	Additional Mold Die with 4 Cavities	Additional Production Site	Additional Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX19004S51 MX19004S52	J & K (Production Site: JAE Akishima Plant)	(L & M) & (N & P)	JAE Hirosaki (HAE)	Middle of January 2017	Beginning of February 2017	Middle of March 2017

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
2. If you need PC PPAP documents, please notify us no later than **11/03/16** in order for factory to prepare and submit by the proposed time.

For any questions regarding this matter, please contact Nina Duong at [duongn@jae.com](mailto:duongn@jae.com)

**Thank you very much for your cooperation!**